

WHAT IS CLAIMED IS:

1. A top or bottom part for a module chassis, comprising:  
a frame having front and rear frame strips; and  
guide rails that are positioned between the front frame strip and the rear frame strip and aligned in the direction of insertion for the mounting of a circuit board of a plug-in module, wherein the guide rails, in cross section, are formed in a u-shape and include a bottom and two sidewalls, at least one of the sidewalls having at least one lateral void, the void of the at least one sidewall corresponding with at least one contact area at a lower edge of the circuit board.
2. The top or bottom part of claim 1, wherein both sidewalls of the guide rail each have at least one void.
3. The top or bottom part of claim 2, wherein the voids are positioned in pairs opposite each other.
4. The top or bottom part of claim 1, wherein a distance between the sidewalls of the guide rail corresponds with a thickness of the circuit board.
5. The top or bottom part of claim 1, wherein the sidewalls are separated from the bottom of the guide rail in the area of the at least one void so that a slit-like opening is created.
6. The top or bottom part of claim 1, wherein a junction between the at least one sidewall and the at least one void is slanted or rounded.
7. A top or bottom part for a module chassis, comprising:  
a frame; and

one or more guide rails attached to the frame and adapted to hold a circuit board, each guide rail having a bottom and a pair of sidewalls, at least one of the pair of sidewalls having at least one lateral void.

8. The top or bottom part of claim 7, wherein the at least one void of the at least one sidewall corresponds with at least one contact area at a lower edge of a circuit board.

9. The top or bottom part of claim 7, wherein the one or more guide rails are aligned in the direction of insertion for the mounting of the circuit board.

10. The top or bottom part of claim 7, wherein both sidewalls of the guide rail each have at least one void.

11. The top or bottom part of claim 10, wherein the voids are positioned in pairs opposite each other.

12. The top or bottom part of claim 7, wherein a distance between the sidewalls of the guide rail corresponds with a thickness of the circuit board.